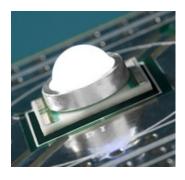


XLamp® XR-C LEDs



PRODUCT DESCRIPTION

The XLamp® XR-C LED gives lighting • designers the flexibility and performance to • create the next generation of LED lighting • products. XLamp XR-C LEDs feature electrically neutral thermal path, low • thermal resistance and support for a wide • range of drive currents.

XLamp LEDs bring high performance and quality of light to a wide range of lighting • applications, including color-changing, • portable and personal, outdoor, indoordirectional, transportation, stage and studio, commercial and emergency-vehicle lighting.

FEATURES

- Available in amber, red-orange & red
- Maximum drive current: up to 700 mA
- Low thermal resistance: as low as 12 °C/W
- Maximum junction temperature: 150 °C
- Industry-leading JEDEC standard pre-qualification testing
- Reflow solderable JEDEC J-STD-020C compatible
- Electrically neutral thermal path
- RoHS and REACH compliant
- UL® recognized component (E349212)

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Cree LED / 4001 E. Hwy. 54, Suite 2000 / Durham, NC 27709 USA / +1.919.313.5330 / www.cree-led.com



CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		15	
Viewing angle (FWHM)	degrees		90	
Temperature coefficient of voltage - red-orange, red	mV/°C		-2.3	
Temperature coefficient of voltage - amber	mV/°C		-1.8	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current - red-orange, red	mA			700
DC forward current - amber	mA			350
Reverse voltage	V			5
Forward voltage (@ 350 mA)	V		2.2	2.5
Forward voltage (@ 700 mA) - red-orange, red	V		2.4	
LED junction temperature*	°C			150

^{*} Note: For lumen maintenance data, see the XLamp LED Reliability document.



FLUX CHARACTERISTICS (T_J = 25 °C)

The following tables list standard kit numbers and performance bins for XR-C color LEDs. Kit numbers completely describe an order code's chromaticity regions and luminous flux range. For a complete description of the order-code nomenclature, please consult the Bin and Order Code Formats section (page 10).

	Minimum Lum	inous Flux (lm)		Dominant Wa	velength (nm)							
Color @ 35		0 mA	Minimum		Maximum		Kit Number	Order Code				
		Flux (lm)	Group	DWL (nm)	Group	DWL (nm)						
		23.5	A2	585	A3	595	00J01	XRCAMB-L1-0000-00J01				
	J		23.5	23.5	23.5	23.3	23.3	A3	590	A3	595	00J03
Amber	K2	00.6	A2	585	A3	595	00K01	XRCAMB-L1-0000-00K01				
Amber		KZ	30.6	A3	590	A3	595	00K03	XRCAMB-L1-0000-00K03			
	M2	39.8	A2	585	A3	595	00M01	XRCAMB-L1-0000-00M01				
		M2	39.8	A3	590	A3	595	00M03	XRCAMB-L1-0000-00M03			

	Minimum Lum	inous Flux (lm)		Dominant Wa	velength (nm)			
Color	@ 35	@ 350 mA		Minimum		Maximum		Order Code
	Group		Group	DWL (nm)	Group	DWL (nm)		
			03	610	04	620	00K01	XRCRDO-L1-0000-00K01
	K2	K2 30.6	03	610	03	615	00K02	XRCRDO-L1-0000-00K02
Red-Orange			04	615	04	620	00K03	XRCRDO-L1-0000-00K03
Red-Orange			03	610	04	620	00M01	XRCRDO-L1-0000-00M01
M2	M2	M2 39.8	03	610	03	615	00M02	XRCRDO-L1-0000-00M02
				04	615	04	620	00M03

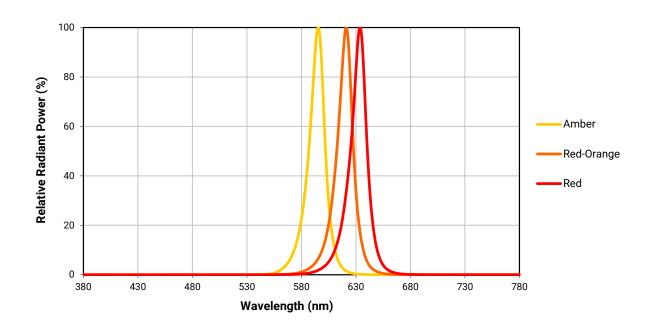
	Minimum Lum	inous Flux (lm)		Dominant Wa	velength (nm)						
Color	@ 350 mA		Minimum		Maximum		Kit Number	Order Code			
Group		Flux (lm)	Group	DWL (nm)	Group	DWL (nm)					
	_	23.5	R2	620	R3	630	00J01	XRCRED-L1-0000-00J01			
	J		23.3	23.3	20.0	20.0	R2	620	R2	625	00J02
Red	K2	30.6	R2	620	R3	630	00K01	XRCRED-L1-0000-00K01			
Reu		KZ 30.0	KZ 50.0	R2	620	R2	625	00K02	XRCRED-L1-0000-00K02		
	M2	39.8	R2	620	R3	630	00M01	XRCRED-L1-0000-00M01			
		M2 39.8	R2	620	R2	625	00M02	XRCRED-L1-0000-00M02			

Notes:

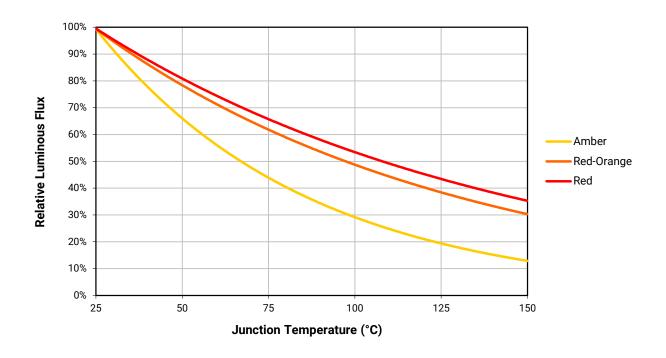
- Cree LED maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 12).
- XR-C LED order codes specify only a minimum flux bin and not a maximum. Cree LED may ship reels in flux bins higher than the minimum specified by the order code without advance notice. Shipments will always adhere to the chromaticity or DWL bin restrictions specified by the order code.



RELATIVE SPECTRAL POWER DISTRIBUTION

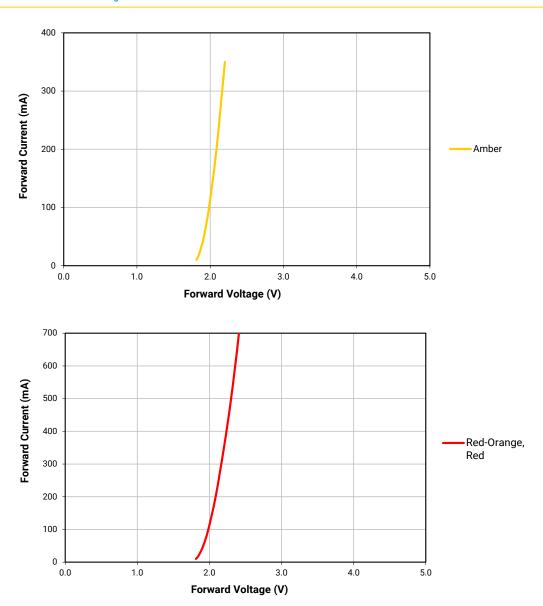


RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 350 \text{ mA}$)



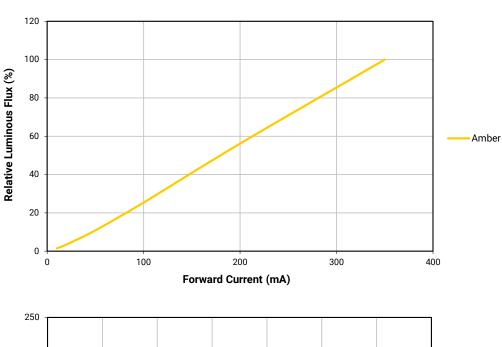


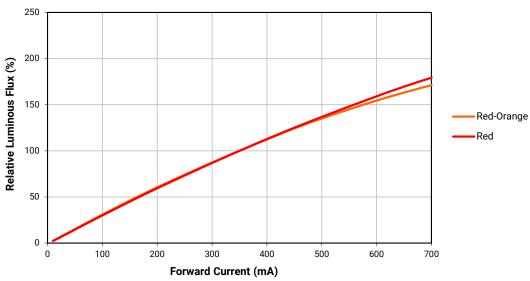
ELECTRICAL CHARACTERISTICS (T_J = 25 °C)





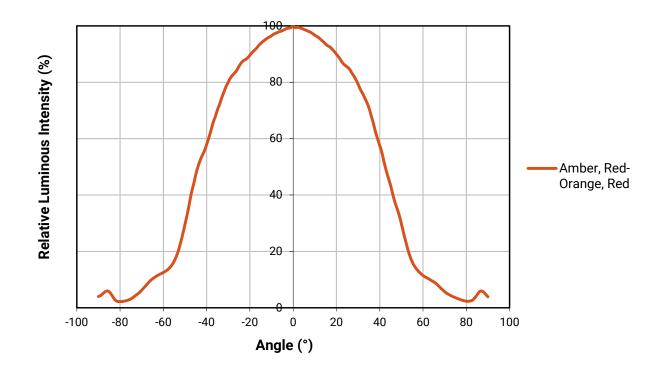
RELATIVE FLUX VS. CURRENT (T $_{\rm J}$ = 25 °C)







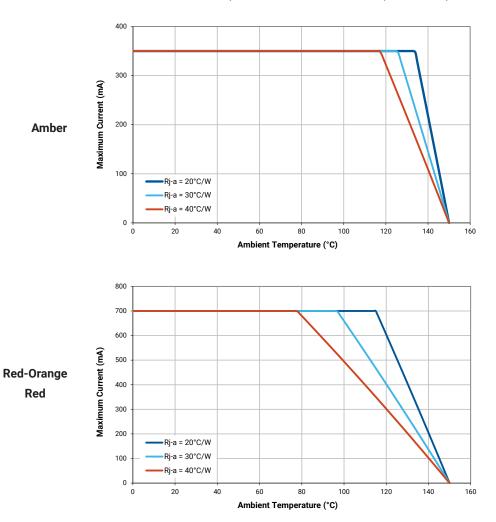
TYPICAL SPATIAL DISTRIBUTION





THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. Given an existing thermal resistance of 12 °C/W or 15 °C/W between the junction and the solder point, it is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.





PERFORMANCE GROUPS - BRIGHTNESS

Amber, red-orange and red XR-C LEDs are tested for luminous flux and placed into one of the following luminous-flux groups:

Group	Minimum Luminous Flux @ 350 mA (lm)	Maximum Luminous Flux @ 350 mA (lm)
J	23.5	30.6
K2	30.6	35.2
K3	35.2	39.8
M2	39.8	45.7
M3	45.7	51.7
N2	51.7	56.8
N3	56.8	62.0
N4	62.0	67.2

PERFORMANCE GROUPS - DOMINANT WAVELENGTH

Color XR-C LEDs are tested for dominant wavelength (DWL) and placed into one of the DWL groups defined below.

Color	DWL Group	Minimum DWL (nm) @ 350 mA	Maximum DWL (nm) @ 350 mA
Amber	A2	585	590
Ambei	A3	590	595
Red-Orange	03	610	615
	04	615	620
Dod	R2	620	625
Red	R3	625	630

PERFORMANCE GROUPS - FORWARD VOLTAGE

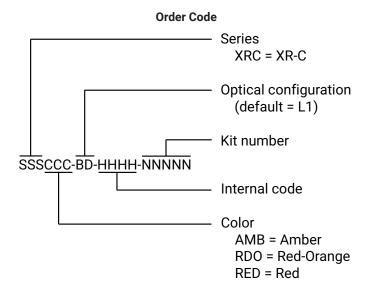
Amber, red-orange and red XR-C LEDs are tested for forward voltage and placed into one of the forward voltage groups defined below.

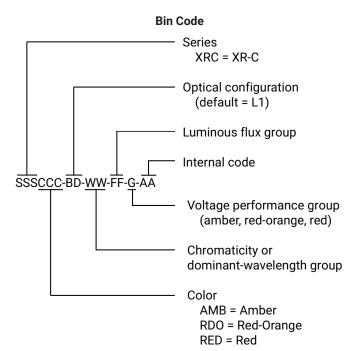
Forward Voltage Group	Minimum Forward Voltage @ 350 mA	Maximum Forward Voltage @ 350 mA
В	1.75	2.0
С	2.0	2.25
D	2.25	2.5



BIN AND ORDER CODE FORMATS

Bin codes and order codes are configured in the following manner:



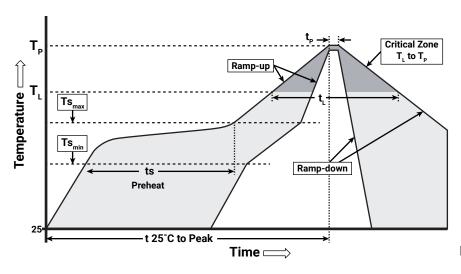




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree LED has found XR-C LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree LED recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used, and therefore it is the lamp or luminaire manufacturer's responsibility to determine applicable soldering requirements.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	1.2 °C/second
Preheat: Temperature Min (Ts _{min})	120 °C
Preheat: Temperature Max (Ts _{max})	170 °C
Preheat: Time (ts _{min} to ts _{max})	65-150 seconds
Time Maintained Above: Temperature (T _L)	217 °C
Time Maintained Above: Time (t _L)	45-90 seconds
Peak/Classification Temperature (Tp)	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



NOTES

Measurements

The luminous flux, radiant power, chromaticity, forward voltage and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree LED's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended or provided as specifications.

Pre-Release Qualification Testing

Please read the LED Reliability Overview for details of the qualification process Cree LED applies to ensure long-term reliability for XLamp LEDs and details of Cree LED's pre-release qualification testing for XLamp LEDs.

Lumen Maintenance

Cree LED now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree LED's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature

Moisture Sensitivity

Cree LED recommends keeping XLamp XR-C LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XR-C LEDs should be handled and stored as MSL 4 per JEDEC J-STD-033, meaning they have limited exposure time before damage to the LED may occur during the soldering operation. The table on the right specifies the maximum exposure time in days depending on temperature and humidity conditions. LEDs with exposure time longer than the specified maximums must be baked according to the baking conditions listed below.

Temp.	Maximum Percent Relative Humidity								
remp.	30%	40%	50%	60%	70%	80%	90%		
30 °C	9	5	4	3	1	1	1		
25 °C	12	7	5	4	2	1	1		
20 °C	17	9	7	6	2	2	1		

Baking Conditions

It is not necessary to bake all XLamp LEDs. Only the LEDs that meet all of the following criteria must be baked:

LEDs that have been removed from the original MBP.

LEDs that have been exposed to a humid environment longer than listed in the Moisture Sensitivity section above.

LEDs that have not been soldered.

LEDs should be baked at 70 °C for 24 hours. LEDs may be baked on the original reels. Remove LEDs from the MBP before baking. Do not bake parts at temperatures higher than 70 °C. This baking operation resets the exposure time as defined in the Moisture Sensitivity section above.



NOTES - CONTINUED

Storage Conditions

XLamp LEDs that have been removed from the original MBP but not soldered yet should be stored in a room or cabinet that will maintain an atmosphere of 25 ± 5 °C and no greater than 10% RH (relative humidity). For LEDs stored in these conditions, storage time does not add to exposure time as defined in the Moisture Sensitivity section above.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree LED representative or from the Product Ecology section of the Cree LED website.

REACH Compliance

REACH substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree LED representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

UL® Recognized Component

This product meets the requirements to be considered a UL Recognized Component with Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

Vision Advisory

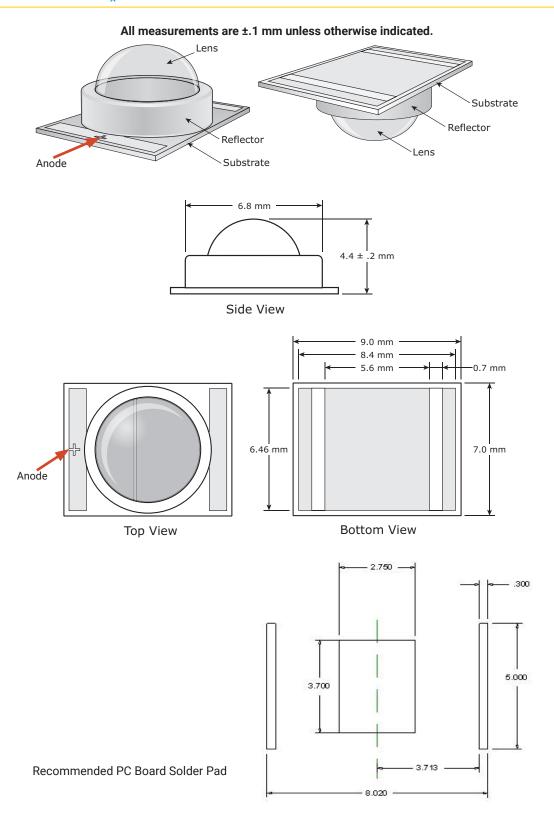
WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

Intellectual Property

For remote phosphor applications, a separate license to certain Cree LED patents is required.



MECHANICAL DIMENSIONS ($T_A = 25$ °C)

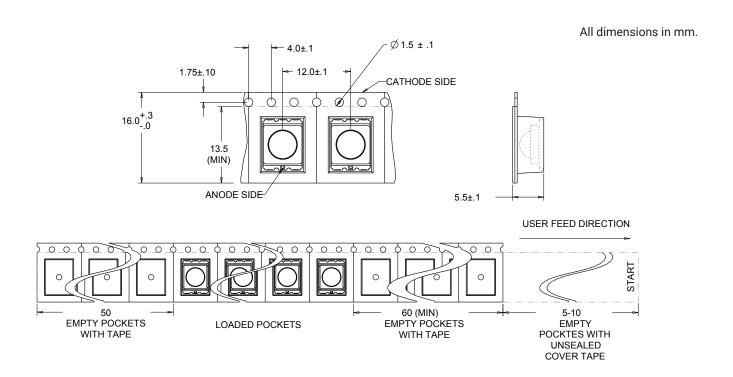


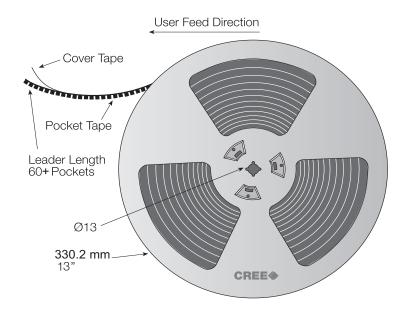
CLD-DS10 REV 17



TAPE AND REEL

All Cree LED carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.







PACKAGING

